

Inermal Characteristics								
Parameter		Symbol	Тур	Max	Units			
Maximum Junction-to-Ambient ^A	t ≤ 10s	$R_{ ext{ heta}JA}$	31	40	°C/W			
Maximum Junction-to-Ambient ^A	Steady State	ν _θ ja	59	75	°C/W			
Maximum Junction-to-Lead ^C	Steady State	$R_{ ext{ heta}JL}$	16	24	°C/W			



Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Тур	Max	Units
STATIC P	ARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	$I_{\rm D} = 250 \mu A, V_{\rm GS} = 0 V$		40			V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 40V, V_{GS} = 0V$				1	μA
	Zero Gale Voltage Drain Gurrent	$T_J = 55^{\circ}C$				5	μΛ
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V, V_{GS} = \pm 20V$	/			±100	nA
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$		1.7	2.2	3	V
I _{D(ON)}	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$		120			А
R _{DS(ON)}		$V_{GS} = 10V, I_{D} = 10A$			8.2	10	
	Static Drain-Source On-Resistance		T _J =125°C		12.5	16	mΩ
		$V_{GS} = 4.5V, I_{D} = 8A$			10	12.5	
g _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$			75		S
V _{SD}	Diode Forward Voltage	$I_{\rm S} = 1$ A, $V_{\rm GS} = 0$ V			0.72	1	V
I _s	Maximum Body-Diode Continuous Current					2.5	Α
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, f=1MHz			1500	1950	pF
C _{oss}	Output Capacitance				215		pF
C _{rss}	Reverse Transfer Capacitance				135		pF
R _g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz		2	3.5	5	Ω
SWITCHI	NG PARAMETERS						
Q _g (10V)	Total Gate Charge	V _{GS} =10V, V _{DS} =20V, I _D =10A			27.2	37	nC
Q _g (4.5V)	Total Gate Charge				13.6	18	nC
Q _{gs}	Gate Source Charge				4.5		nC
Q _{gd}	Gate Drain Charge				6.4		nC
t _{D(on)}	Turn-On DelayTime	V_{GS} =10V, V_{DS} =20V, R_{L} = 2 Ω , R_{GEN} =3 Ω			6.4		ns
t _r	Turn-On Rise Time				17.2		ns
t _{D(off)}	Turn-Off DelayTime				29.6		ns
t _f	Turn-Off Fall Time				16.8		ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=100A/μs			30	40	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dl/dt=100A/μs			19		nC

A: The value of R_{BJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design.</sub>

B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using t \leqslant 300 μs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^{\circ}$ C. The SOA curve provides a single pulse rating.

F. The current rating is based on the t \leqslant 10s thermal resistance rating.

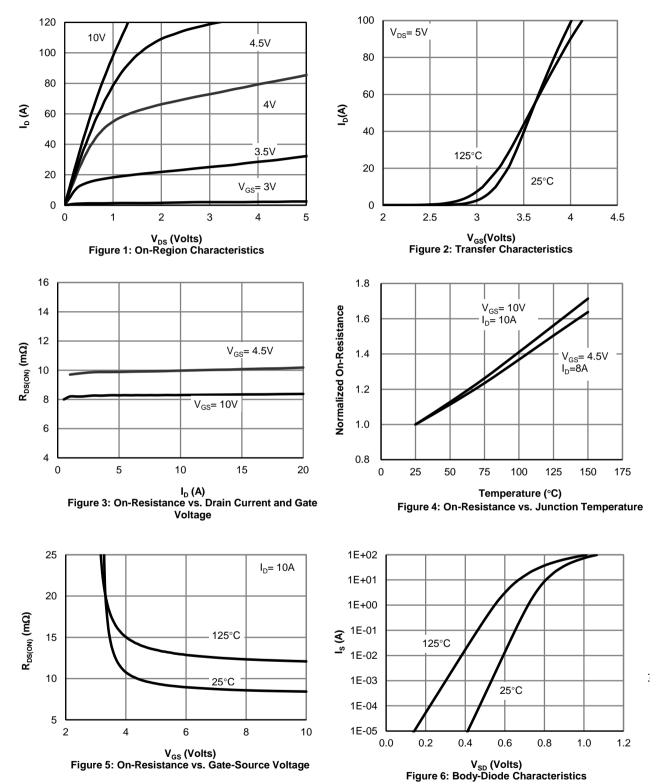
G. E_{AR} and I_{AR} ratings are based on low frequency and duty cycles to keep T_i=25C.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS





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